

PRODUCT DATASHEET Iris series

last update 27/9/2013





Ordering number FCN12076_IRIS-SCREW

Family Iris Type LED XP-G Color Black Diameter 38 mm Height 26.9 mm Style Round PMMA Optic Material PC Holder Material

Fastening Screw, pin, glue

Status Ready

Ordering number FCA12077_IRIS

Family Type Assembly LED XP-G Color Black Diameter 38 mm Height 27.1 mm Style Round **PMMA** Optic Material Holder Material PC

Fastening Screw, pin, tape

Status Ready

FWHM 6 degrees
Efficiency 95 %
cd/lm Gerber File Available

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Efficiency 95 %
cd/lm Gerber File Available

NOTE: The typical divergence will be changed by different color, chip size and chip position tolerance. The typical total divergence is the full angle measured where the luminous intensity is half of the peak value.



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GENERAL INFORMATION

- Product series especially designed & optimized for XP-G series of LEDs.
- Special care taken to make light distribution as uniform as possible.
- Lens material optical grade PMMA with high UV and temperature resistance (105 degrees of Celcius / 220 degrees of Fahrenheit). Allows use of high current and temperature conditions.

Please find more information about used material from below:

http://ledil.fi/sites/default/files/Documents/Technical/Material/PMMA%208N%20UL94_Yellow%20Card.pdf http://ledil.fi/sites/default/files/Documents/Technical/Material/PMMA%208N%20PLEXIGLAS-Datasheet.pdf - Optic holder molded by high quality PC material (120 dergees of Celcius / 248 degrees of Fahrenheit).

- Fastening to heat sink with a PU foam adhesive tape of automotive grade. Please find fastening details by clicking link: http://www.ledil.com/datasheets/DataSheet TAPE.pdf
- Fastening to PCB with appropriate adhesive. By clicking link below you can find Ledil recommended glue options.

http://www.ledil.com/datasheets/DataSheet_GLUES.pdf

NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit boar weaken the strength of the tape.

NOTE 2: Assembly to the surface must be made straight, so the tape bonds constant and balanced with fastening surface. Slanted assembly might cause unbalanced bond to the surface. All surfaces where tape is applied must be clean, dry and free from grease and dirt.

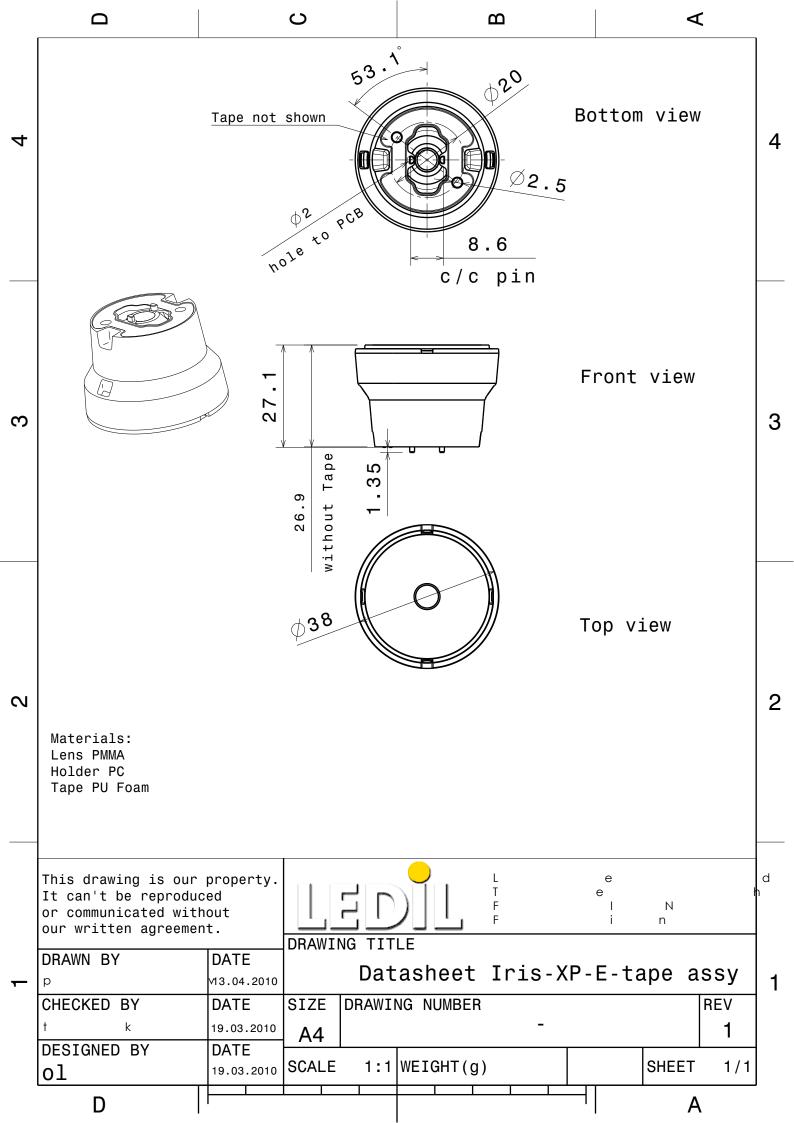
If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer - this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.

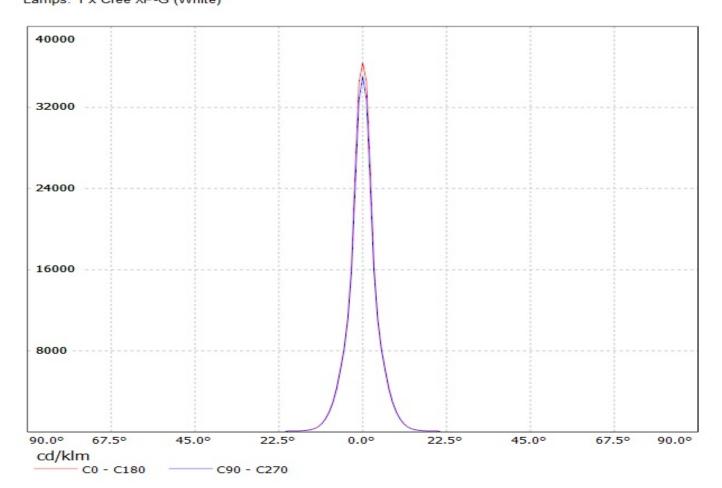
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Luminaire: Ledil Oy Iris-XP-G Iris-XP-G Lamps: 1 x Cree XP-G (White)



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